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FQD3P50 P-Channel QFET[®] MOSFET - 500 V, - 2.1 A, 4.9 Ω

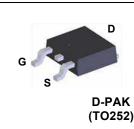
Description

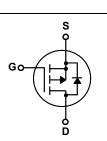
This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor[®]'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

May 2015

Features

- 2.1 A, 500 V, ${\sf R}_{\sf DS(on)}$ = 4.9 Ω (Max.) @ ${\sf V}_{\sf GS}$ = 10 V, ID = 1.05 A
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 9.5 pF)
- 100% Avalanche Tested





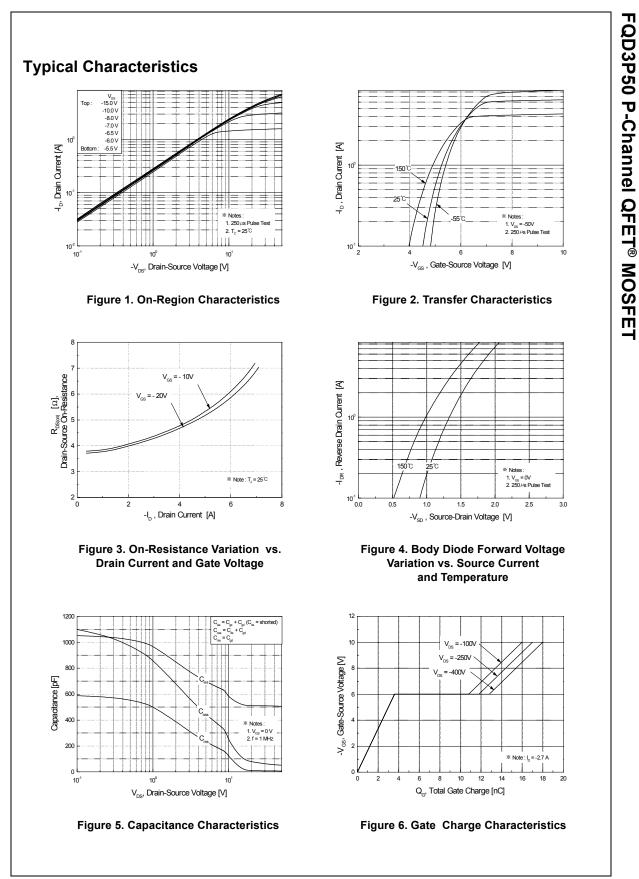
Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter		FQD3P50	Unit	
V _{DSS}	Drain-Source Voltage		-500	V	
ID	Drain Current - Continuous (T _C = 25°C)		-2.1	А	
	- Continuous (T _C = 10	0°C)	-1.33	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	-8.4	А	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	250	mJ	
I _{AR}	Avalanche Current	(Note 1)	-2.1	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.0	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns	
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *		2.5	W	
	Power Dissipation ($T_C = 25^{\circ}C$)		50	W	
	- Derate above 25°C		0.4	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

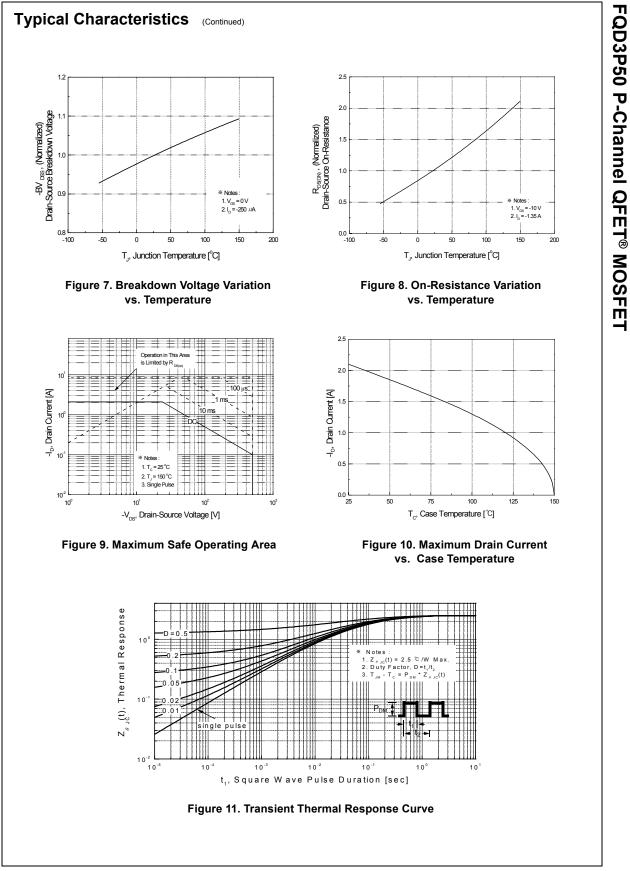
Symbol	Parameter	FQD3P50	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max. *	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	110	°C/W

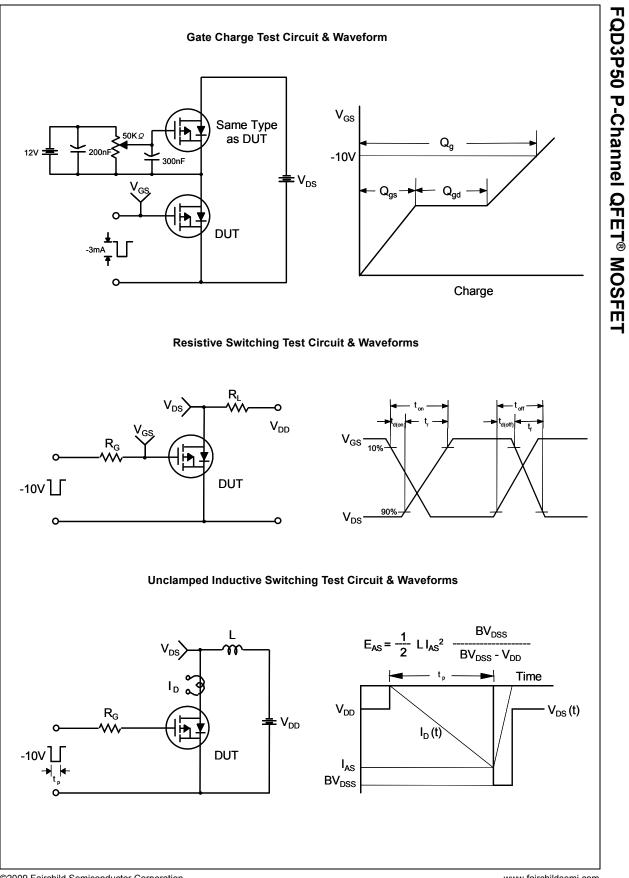
	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	iracteristics					
BV _{DSS}						V
ΔBV _{DSS}	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C	-500	0.42		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -500 V, V _{GS} = 0 V			-1	μA
		$V_{DS} = -400 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-3.0		-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -1.05 A		3.9	4.9	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -50 V, I _D = -1.05 A		2.1		S
_					1	
	ic Characteristics	Ι				_
C _{iss}	Input Capacitance	$V_{\rm DS}$ = -25 V, $V_{\rm GS}$ = 0 V,		510	660	pF
C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		70 9.5	90 12	pF pF
d(on)	ng Characteristics Turn-On Delay Time Turn On Diag Time	V _{DD} = -250 V, I _D = -2.7 A,		12	35	ns
t _r	Turn-On Rise Time	$V_{DD} = -250 \text{ V}, \text{ I}_{D} = -2.7 \text{ A},$ R _G = 25 Ω		56	120	ns
t _{d(off)}	Turn-Off Delay Time	_ 1(g - 20 32		35	80	ns
t _f	Turn-Off Fall Time	(Note 4)		45	100	ns
Qg	Total Gate Charge	V _{DS} = -400 V, I _D = -2.7 A,		18	23	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		3.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		9.2		nC
	ource Diode Characteristics an Maximum Continuous Drain-Source Dio				-2.1	A
ls	Maximum Pulsed Drain-Source Diode F	ain-Source Diode Forward Current			-8.4	Α
					-5.0	V
I _S I _{SM} V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -2.1 A			0.0	
I _{SM}	Drain-Source Diode Forward Voltage Reverse Recovery Time	$V_{GS} = 0 V, I_S = -2.1 A$ $V_{GS} = 0 V, I_S = -2.7 A,$		270		ns



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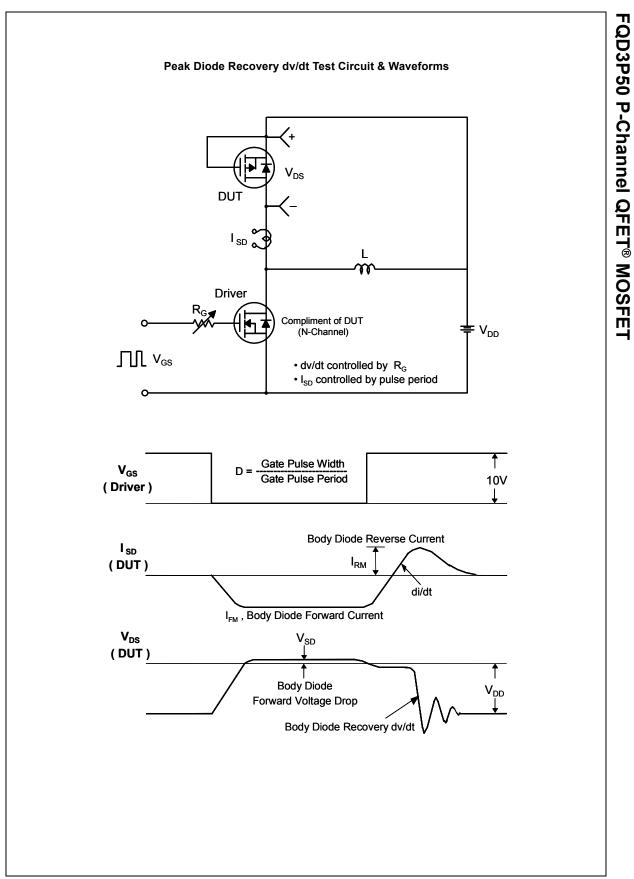
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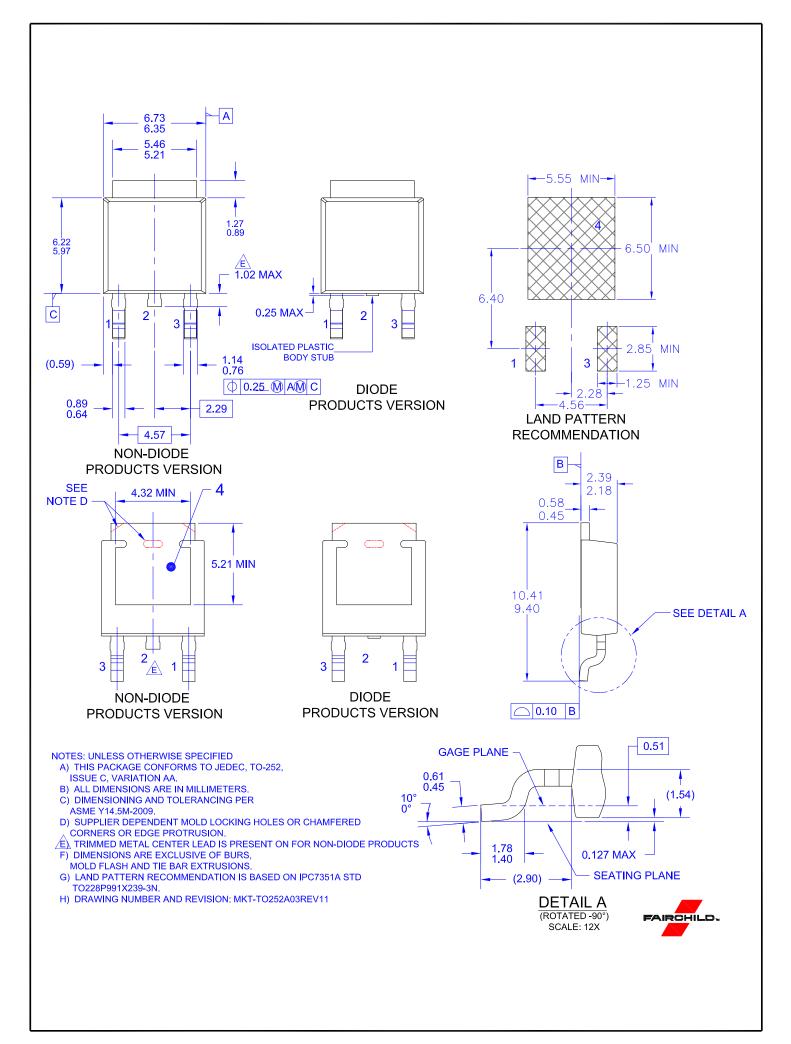




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